AMENDMENTS TO THE ABSTRACT

Please delete the Abstract and insert therefore the following:

A wiring system is provided. Using the system, a wire conductor is stuck on a surface of a substrate by causing a three-dimensional relative movement between a wiring head for guiding the wire conductor and the substrate such that the wiring head relatively moves along an adhesive layer on the surface of the substrate and the wiring head and the adhesive layer intermittently come close to each other for point contact.